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Vishay Siliconix

E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.043			
Q _g max. (nC)	98				
Q _{gs} (nC)	28				
Q _{gd} (nC)	14				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Solar (PV inverters)

ORDERING INFORMATION				
Package	PowerPAK 10 x 12			
Lead (Pb)-free and halogen-free	SIHK045N60E-T1-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	600	V		
Gate-source voltage			V _{GS}	± 30	V		
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	ID	48			
	V _{GS} at 10 V	T _C = 100 °C		31	A		
Pulsed drain current ^a			I _{DM}	138			
Linear derating factor				2.22	W/°C		
Single pulse avalanche energy ^b			E _{AS}	286	mJ		
Maximum power dissipation			PD	278	W		
Operating junction and storage temperature ra	nge		T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope $T_J = 125 \ ^{\circ}C$ Reverse diode dv/dt d		alı . (alt	100	V/ns			
		dv/dt	17	v/ns			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega, \, I_{AS}$ = 4.5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

RoHS



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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R _{thJA}	- 50 °							
Maximum junction-to-case (drain)	R _{thJC}	- 0.45				°C/W			
SPECIFICATIONS ($T_J = 25 \text{ °C}$, u	unless otherwi	se noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μΑ	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.64	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 2$	250 µA	3.0	-	5.0	V	
		$V_{GS} = \pm 20 \text{ V}$			-	-	± 100	nA	
Gate-source leakage	I _{GSS}	V _{GS} = ± 30 V			-	-	± 1	μA	
Zara gata valtaga drain avreat		V _{DS} =	600 V, V _G	_S = 0 V	-	-	1		
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	, V _{GS} = 0 V	∕, T _J = 125 °C	-	-	10	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	ار	_D = 17 A	-	0.043	0.049	Ω	
Forward transconductance ^a	9 _{fs}	V _{DS} :	= 10 V, I _D =	= 35 A	-	22	-	S	
Dynamic	•					•	•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	4013	-	pF		
Output capacitance	C _{oss}			-	148	-			
Reverse transfer capacitance	C _{rss}			-	6	-			
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	117	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	744	-			
Total gate charge	Qg				-	65	98		
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 17 \text{ A}, \text{ V}_{DS} = 480 \text{ V}$		-	28	-	nC	
Gate-drain charge	Q _{gd}				-	14	-		
Turn-on delay time	t _{d(on)}				-	35	70		
Rise time	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 480 \; \text{V}, \; I_{\text{D}} = 17 \; \text{A}, \\ V_{\text{GS}} = 10 \; \text{V}, \; R_{g} = 9.1 \; \Omega \end{array}$		-	40	80	- ns		
Turn-off delay time	t _{d(off)}			-	67	101			
Fall time	t _f			-	14	28			
Gate input resistance	R _g	f = 1 MHz		0.4	0.8	1.6	Ω		
Drain-Source Body Diode Characteristi	cs								
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	48	A		
Pulsed diode forward current	I _{SM}			-	-	148			
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 17 A, V _{GS} = 0 V		-	-	1.2	V		
Reverse recovery time	-			1	<u> </u>				
	t _{rr}				-	403	806	ns	
Reverse recovery charge	t _{rr} Q _{rr}		5 °C, I _F = I _S 100 A/µs, \		-	403 6.5	806 13	ns µC	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

c. When mounted on 1" x 1" FR4 board



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

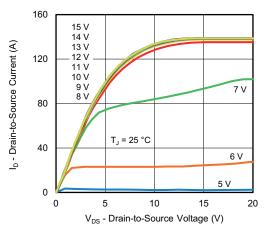


Fig. 1 - Typical Output Characteristics

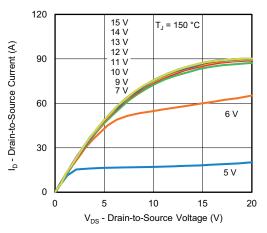


Fig. 2 - Typical Output Characteristics

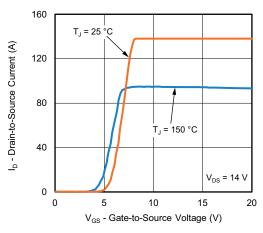


Fig. 3 - Typical Transfer Characteristics

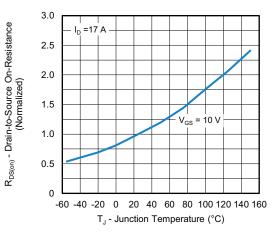


Fig. 4 - Normalized On-Resistance vs. Temperature

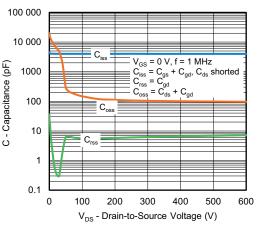


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

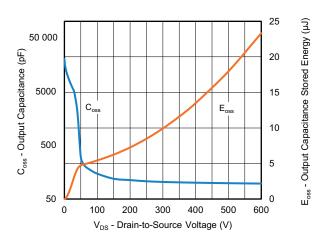


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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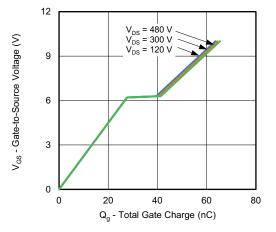


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

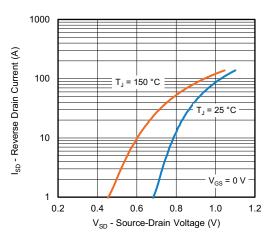


Fig. 8 - Typical Source-Drain Diode Forward Voltage

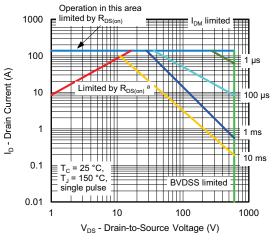


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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4

50

40

30

20

10

0

1.2

1.1

1.0

0.9

0.8

V_{DS} - Drain-to-Source Breakdown Voltage (V) (Normalized) 25

50

75

100

T_C - Case Temperature (°C)

Fig. 10 - Maximum Drain Current vs. Case Temperature

-60 -40 -20 0 20 40 60 80 100 120 140 160

T_J - Junction Temperature (°C)

Fig. 11 - Temperature vs. Drain-to-Source Voltage

125

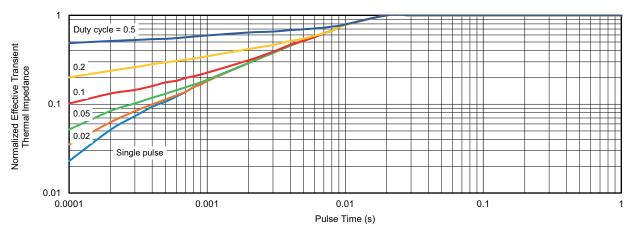
 $I_D = 1 \text{ mA}$

150

I_D - Drain Current (A)



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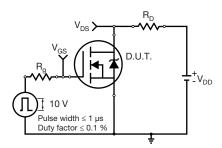


Fig. 13 - Switching Time Test Circuit

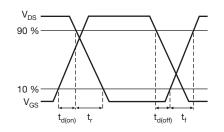


Fig. 14 - Switching Time Waveforms

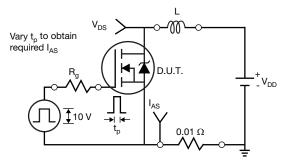


Fig. 15 - Unclamped Inductive Test Circuit

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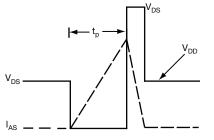


Fig. 16 - Unclamped Inductive Waveforms

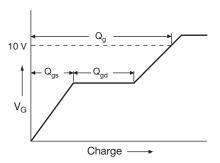
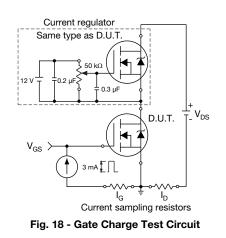


Fig. 17 - Basic Gate Charge Waveform



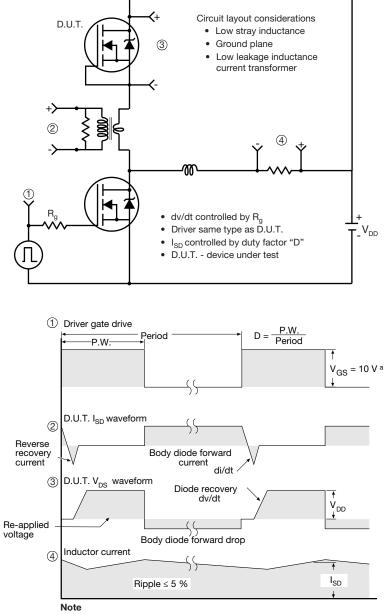
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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

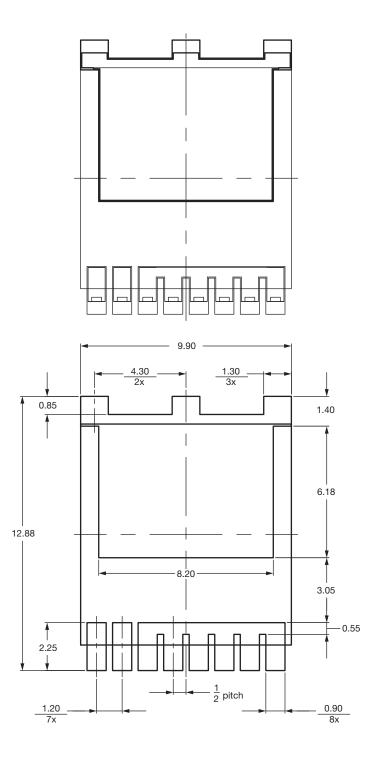
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PAD Pattern



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Recommended Land Pattern PowerPAK[®] 10 x 12 (TOLL) (High Voltage)



Note

• Dimensions in mm

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Revision: 26-Dec-2022

1 hnical questions, contact: hvm@vis Document Number: 92489

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